

NCE N and P-Channel Enhancement Mode Power MOSFET

Description

The NCE6602N uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge. This device is suitable for use as a Battery protection or in other Switching application.

General Features

N-Channel

• $V_{DS} = 30V, I_D = 3.5A$ $R_{DS(ON)} < 58m\Omega @ V_{GS} = 10V$

P-Channel

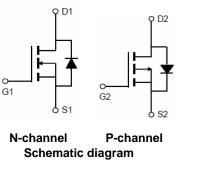
 $V_{DS} = -30V, I_{D} = -2.7A$

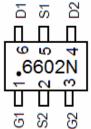
 $R_{DS(ON)}$ < 100m Ω @ V_{GS} =-10V

 $R_{DS(ON)}$ < 95m Ω @ V_{GS} =4.5V

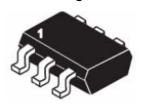
 $R_{DS(ON)}$ < 150m Ω @ V_{GS} =-4.5V

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage





Pin Assignment



SOT23-6L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
6602N	NCE6602N	SOT23-6L	Ø180mm	8mm	3000 units

Absolute Maximum Ratings (T_A=25℃unless otherwise noted)

	,				
Parame	Symbol	N-Channel	P-Channel	Unit	
Drain-Source Voltage		V _{DS}	30	-30	V
Gate-Source Voltage		V _{GS}	±20	±20	V
Continuous Drain Current	T _A =25℃		3.5	-2.7	Α
Continuous Drain Current	T _A =70°C	I _D	3	-2.1	
Pulsed Drain Current (Note 1)		I _{DM}	20	-15	Α
Maximum Power Dissipation	T _A =25℃	P _D	1.2		W
Operating Junction and Storage T	T_{J} , T_{STG}	-55 To 150	-55 To 150	$^{\circ}$ C	

Thermal Characteristic

Thermal Resistance,Junction-to-Ambient (Note2)	$R_{\theta JA}$	N-Ch	104	°C/W
Thermal Resistance,Junction-to-Ambient (Note2)	$R_{\theta JA}$	P-Ch	104	°C/W



N-CH Electrical Characteristics (T_A=25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	30	33	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						•
Gate Threshold Voltage	$V_{GS(th)}$	V _{DS} =V _{GS} ,I _D =250μA	1.2	1.5	2.2	V
Drain-Source On-State Resistance	Б	V _{GS} =10V, I _D =3.5A	-	36	58	mΩ
Diam-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =2A	-	60	95	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =3.1A	-	4	-	S
Dynamic Characteristics (Note4)						•
Input Capacitance	C _{lss}	\/ -15\/\/ -0\/	-	251	-	PF
Output Capacitance	Coss	V_{DS} =15V, V_{GS} =0V, F=1.0MHz	-	38	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0IVIH2	-	32	-	PF
Switching Characteristics (Note 4)			•			•
Turn-on Delay Time	t _{d(on)}		-	4.5	-	nS
Turn-on Rise Time	t _r	V_{DD} =15V, R_L =3 Ω	-	1.5	-	nS
Turn-Off Delay Time	$t_{\sf d(off)}$	V_{GS} =10 V , R_{GEN} =6 Ω	-	18.5	-	nS
Turn-Off Fall Time	t _f		-	15.5	-	nS
Total Gate Charge	Qg	\/ _45\/ _2.5A	-	10.0	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =15V, I_{D} =3.5A, V_{GS} =10V	-	1.9	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} = 10 V	-	1.8	-	nC
Drain-Source Diode Characteristics			•	•		•
Diode Forward Voltage (Note 3)	V_{SD}	V _{GS} =0V,I _S =3.5A	-	0.8	1.2	V
Diode Forward Current (Note 2)	I _S		-	-	3.5	Α

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production



P-CH Electrical Characteristics (T_A=25 ℃ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250μA		-33	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-30V,V _{GS} =0V	-	-	-1	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	$V_{GS(th)}$	V _{DS} =V _{GS} ,I _D =-250μA	-1	-1.6	-2.5	V
Davis Course On Otata Basistana		V _{GS} =-10V, I _D =-2.7A	-	69	100	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-2A	-	110	150	mΩ
Forward Transconductance	g fs	V _{DS} =-10V,I _D =-2.7A		2	-	S
Dynamic Characteristics (Note4)			•			
Input Capacitance	C _{lss}	- V _{DS} =-15V,V _{GS} =0V, F=1.0MHz		278	-	PF
Output Capacitance	C _{oss}			43	-	PF
Reverse Transfer Capacitance	C _{rss}			35	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	8	-	nS
Turn-on Rise Time	t _r	V_{DD} =-15 V , R_L =15 Ω	-	5	-	nS
Turn-Off Delay Time	$t_{d(off)}$	V_{GS} =-10V, R_{GEN} =6 Ω	-	12	-	nS
Turn-Off Fall Time	t _f		-	4	-	nS
Total Gate Charge	Qg		-	5.8	-	nC
Gate-Source Charge	Q_{gs}	V _{DS} =-15V,I _D =-2.7A,V _{GS} =-10V	-	1	-	nC
Gate-Drain Charge	Q_{gd}		-	1.1	-	nC
Drain-Source Diode Characteristics			•			
Diode Forward Voltage (Note 3)	V_{SD}	V _{GS} =0V,I _S =-2.7A	-	-	-1.2	V

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production



N- Channel Typical Electrical and Thermal Characteristics

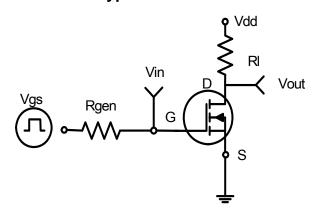
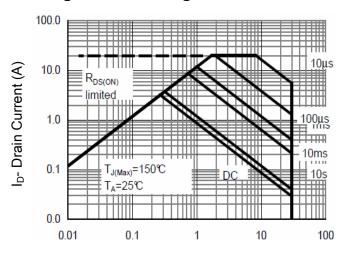


Figure 1:Switching Test Circuit



Vds Drain-Source Voltage (V)
Figure 3 Safe Operation Area

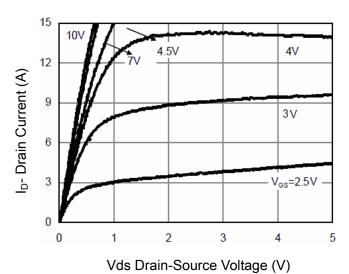


Figure 5 Output Characteristics

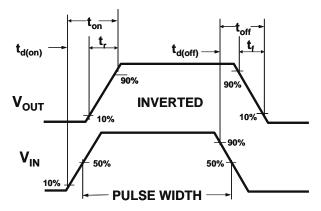


Figure 2:Switching Waveforms

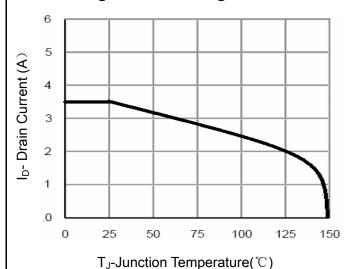


Figure 4 Drain Current

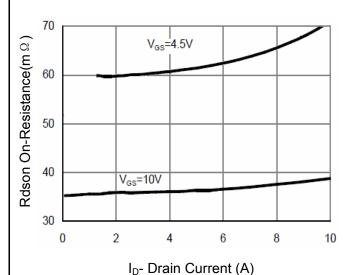


Figure 6 Drain-Source On-Resistance



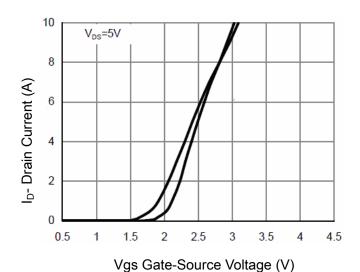
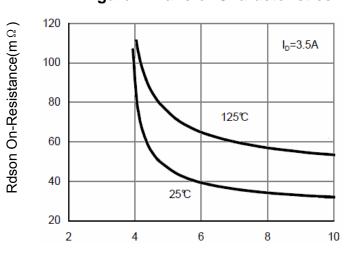


Figure 7 Transfer Characteristics



Vgs Gate-Source Voltage (V)

Figure 9 Rdson vs Vgs

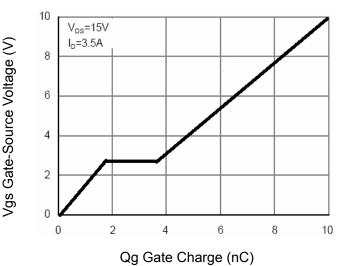
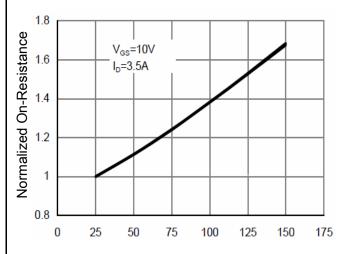
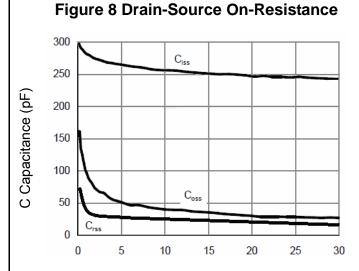


Figure 11 Gate Charge



 $\mathsf{T}_{\mathsf{J}} ext{-}\mathsf{Junction}\;\mathsf{Temperature}(^{\circ}\!\mathbb{C}\,)$



Vds Drain-Source Voltage (V)

Figure 10 Capacitance vs Vds

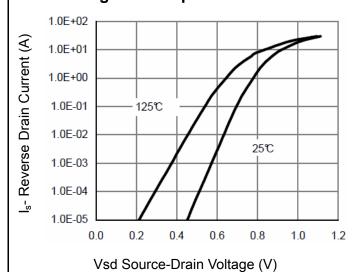


Figure 12 Source- Drain Diode Forward



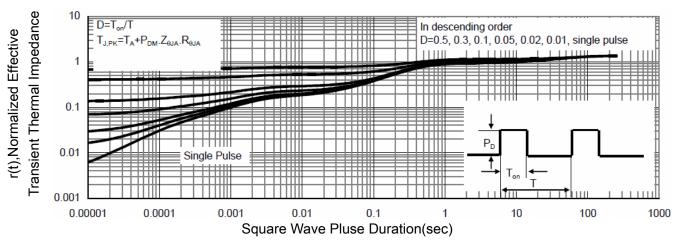


Figure 13 Normalized Maximum Transient Thermal Impedance



P- Channel Typical Electrical and Thermal Characteristics

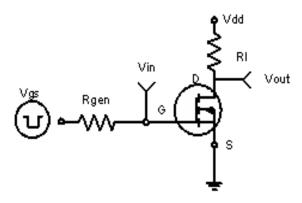


Figure 1:Switching Test Circuit

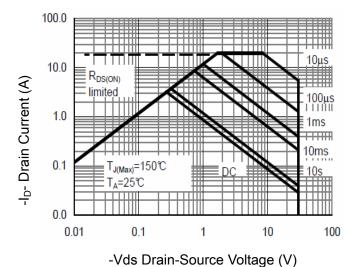


Figure 3 Safe Operation Area

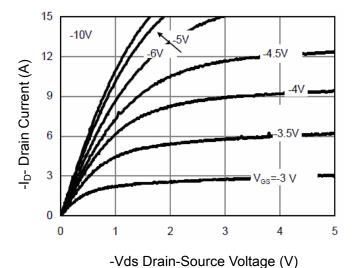


Figure 5 Output Characteristics

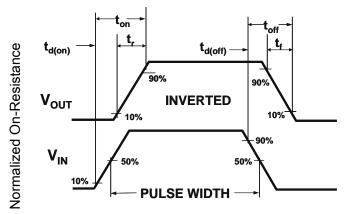


Figure 2:Switching Waveforms

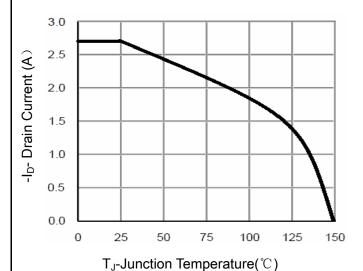


Figure 4 Drain Current

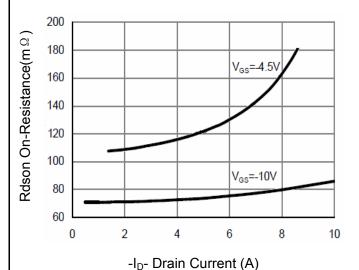


Figure 6 Drain-Source On-Resistance



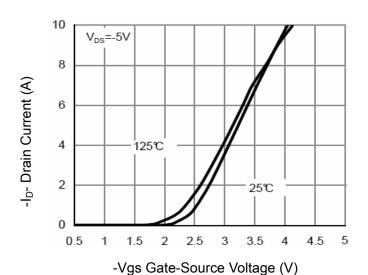
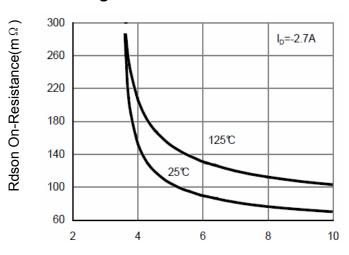
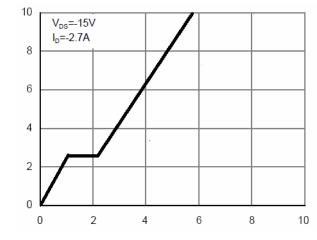


Figure 7 Transfer Characteristics



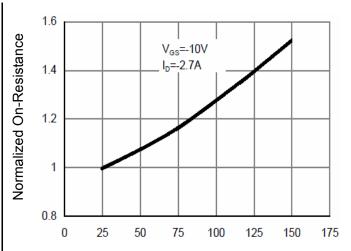
-Vgs Gate-Source Voltage (V)

Figure 9 Rdson vs Vgs

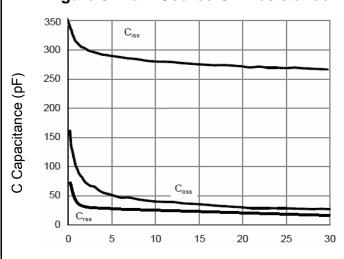


-Vgs Gate-Source Voltage (V)

Qg Gate Charge (nC) Figure 11 Gate Charge

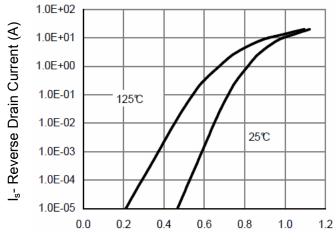


 T_J -Junction Temperature(${}^{\circ}$ C) Figure 8 Drain-Source On-Resistance



-Vds Drain-Source Voltage (V)

Figure 10 Capacitance vs Vds



Vsd Source-Drain Voltage (V)

Figure 12 Source- Drain Diode Forward



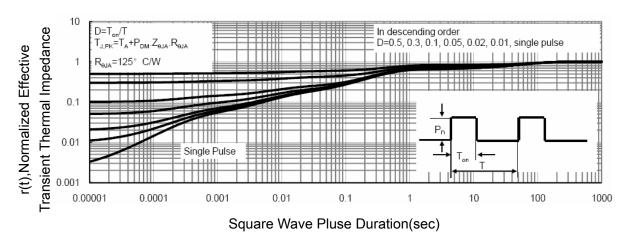
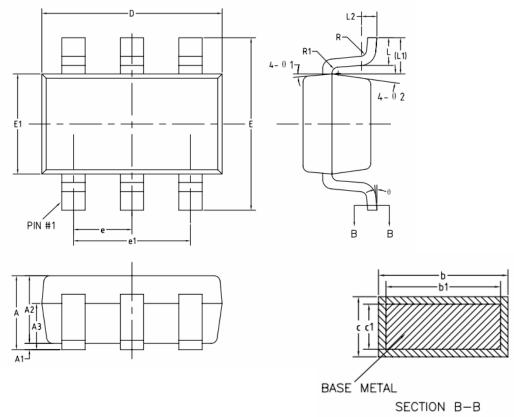


Figure 13 Normalized Maximum Transient Thermal Impedance



SOT23-6L Package Information



COMMON DIMENSIONS
(UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	NOM	MAX		
Α	_	_	1.45		
A1	0	_	0.15		
A2	0.90	1.10	1.30		
A3	0.60	0.65	0.70		
b	0.39	_	0.49		
b1	0.38	0.40	0.45		
С	0.12	_	0.19		
c1	0.11	0.13	0.15		
D	2.85	2.95	3.05		
E	2.60	2.80	3.00		
E1	1.55	1.65	1.75		
е	0.85	0.95	1.05		
e1	1.80	1.90	2.00		
L	0.35	0.45	0.60		
L1		0.59REF			
L2	0.25BSC				
R	0.05	_	_		
R1	0.05	_	0.20		
θ	0,	_	8*		
θ 1	8*	10°	12*		
θ 2	8*	10°	12 °		

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DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 DMN2990UFB-7B
IPB80P04P405ATMA2 2N7002W-G MCAC30N06Y-TP MCQ7328-TP BXP7N65D BXP4N65F AOL1454G WMJ80N60C4 BXP2N20L
BXP2N65D BXT1150N10J BXT1700P06M TSM60NB380CP ROG RQ7L055BGTCR DMNH15H110SK3-13 SLF10N65ABV2
BSO203SP BSO211P IPA60R230P6 IPA60R460CE